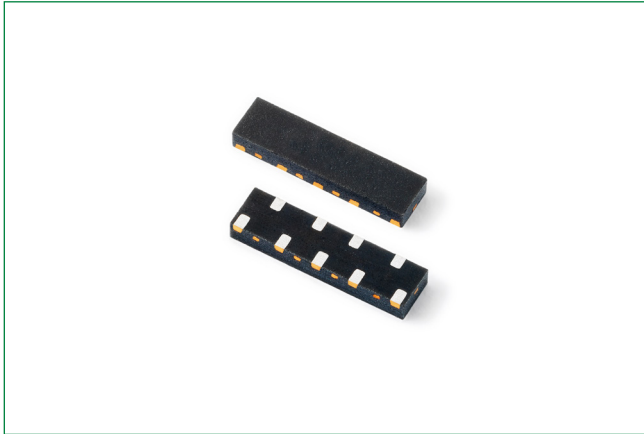


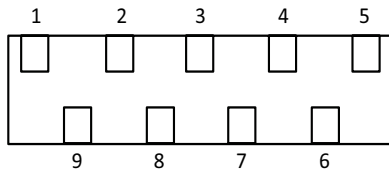
AQ7520-08UTG

0.32pF 12kV Diode Array, Low Capacitance ESD Protection

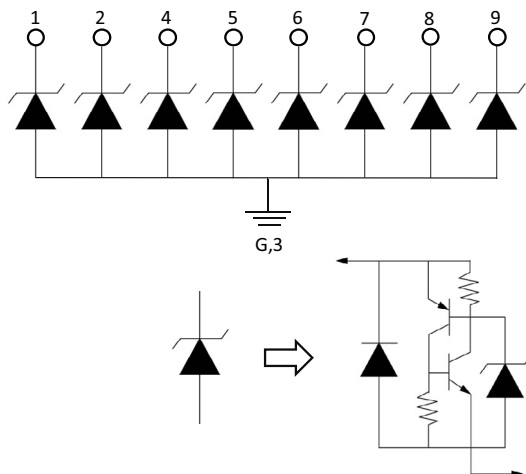


Note: This package image is for example and reference only. for detail package drawing, please refer to the package section in this datasheet.

Pinout



Functional Block Diagram



Description

The AQ7520-08UTG includes eight channels ultra low capacitance and high-level ESD protection diodes to protect high-speed data rate such as USB 3.1, DisplayPort and e-SATA. The typical capacitance of 0.32pF helps ensure signal integrity and this robust device can safely absorb repetitive ESD strikes at the maximum level specified in the IEC 61000-4-2 international standard (Level 4, $\pm 8\text{kV}$ contact discharge) without performance degradation and safely dissipate 6A of 8/20 μs surge current (IEC 61000-4-5 2nd edition).

Features

- ESD, IEC 61000-4-2, $\pm 12\text{kV}$ contact, $\pm 15\text{kV}$ air
- ESD, ISO 10605, 330pF 330 Ω , $\pm 12\text{kV}$ contact, $\pm 12\text{kV}$ air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Maximum surge tolerance, IEC 61000-4-5 2nd edition, 6A ($t_p=8/20\mu\text{s}$)
- Low capacitance of 0.32pF@1.5V (TYP)
- Low leakage current of 0.02 μA (TYP) at 3.3V
- Low operating and clamping voltage
- AEC-Q101 qualified and PPAP capable
- Halogen free, Lead free and RoHS compliant
- Moisture Sensitivity Level (MSL -1)

Applications

- V-By-One
- Embedded DisplayPort
- USB 2.0/3.0/3.1 Ports
- Automotive
- Flat Panel Displays
- LCD/LED TVs
- Smartphones
- Mobile Computing

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications
The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

AQ7520-08UTG**0.32pF 12kV Diode Array, Low Capacitance ESD Protection****Absolute Maximum Ratings**

Symbol	Parameter	Value	Units
I_{PP}	Peak Current ($t_p=8/20\mu s$)	6.0	A
T_{OP}	Operating Temperature	-40 to 150	°C
T_{STOR}	Storage Temperature	-55 to 150	°C

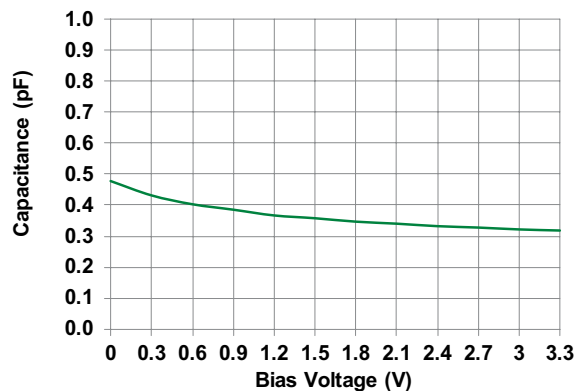
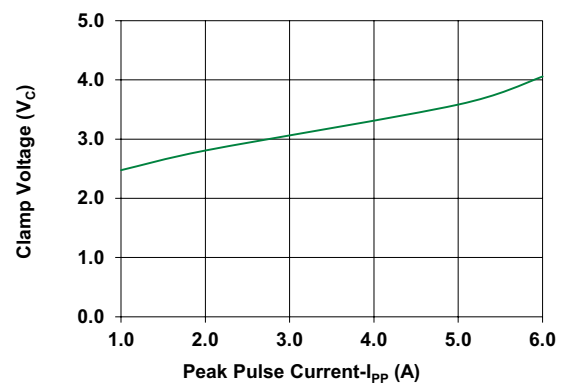
Caution: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics ($T_{OP}=25^\circ C$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V_{RWM}	Pin-1,-2,-4,-5,-6,-7,-8,-9 to pin-3			3.3	V
Breakdown Voltage	V_{BR}	$I_R=1mA$	6.5	8.5		V
Reverse Leakage Current	I_{LEAK}	$V_R=3.3V$		0.02	0.1	μA
Holding Voltage	V_{HOLD}	I/O to GND		1.7		V
Clamp Voltage ¹	V_C	$I_{PP}=1A, t_p=8/20\mu s$		2.7	3.5	V
		$I_{PP}=6A, t_p=8/20\mu s$		4.0	6.0	
Dynamic Resistance ²	R_{DYN}	TLP, $t_p=100ns$		0.25		Ω
ESD Withstand Voltage ^{1,3}	V_{ESD}	IEC 61000-4-2 (Contact Discharge)	± 12			kV
		IEC 61000-4-2 (Air Discharge)	± 15			kV
Diode Capacitance ¹	$C_{I/O-GND}$	Reverse Bias=1.5V, $f=1MHz$		0.32	0.4	pF

Notes:

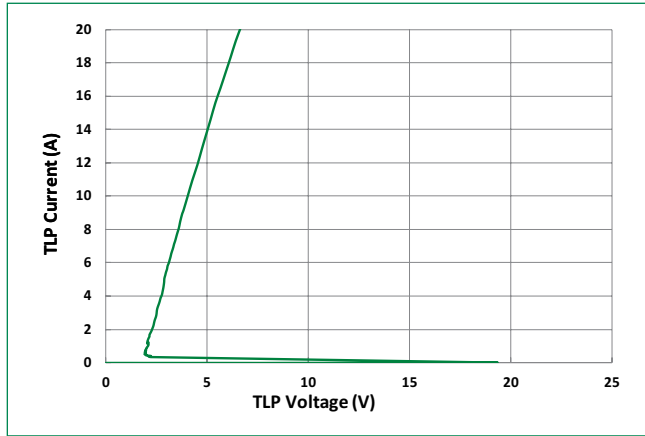
- Parameter is guaranteed by design and/or component characterization.
- Transmission Line Pulse (TLP) with 100ns width, 0.2ns rise time, and average window $t_1=70ns$ to $t_2=90ns$
- Device stressed with ten non-repetitive ESD pulses.

Capacitance vs. Reverse Bias**Clamping Voltage vs I_{PP}** 

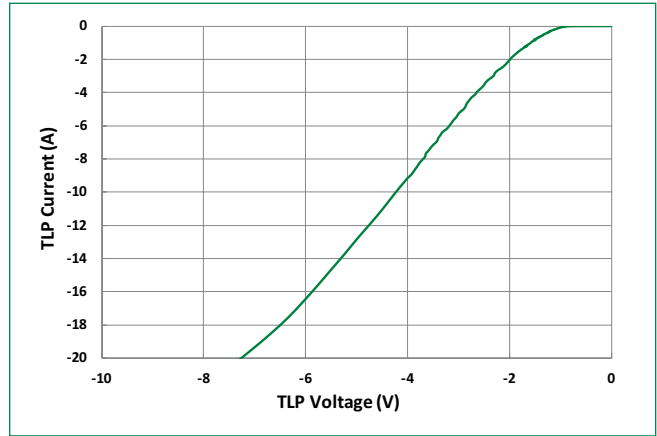
AQ7520-08UTG

0.32pF 12kV Diode Array, Low Capacitance ESD Protection

Positive Transmission Line Pulsing (TLP) Plot



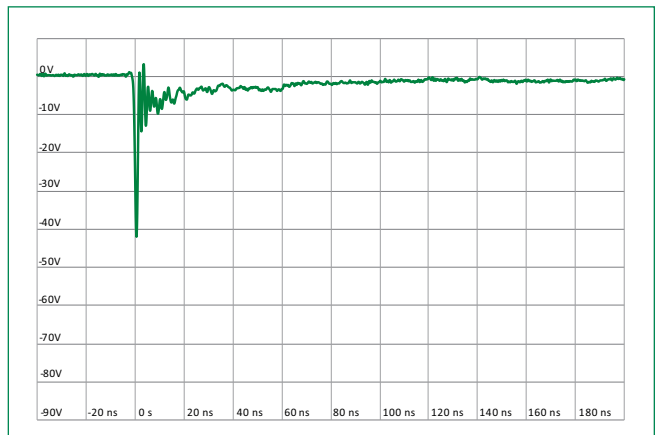
Negative Transmission Line Pulsing (TLP) Plot



IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage



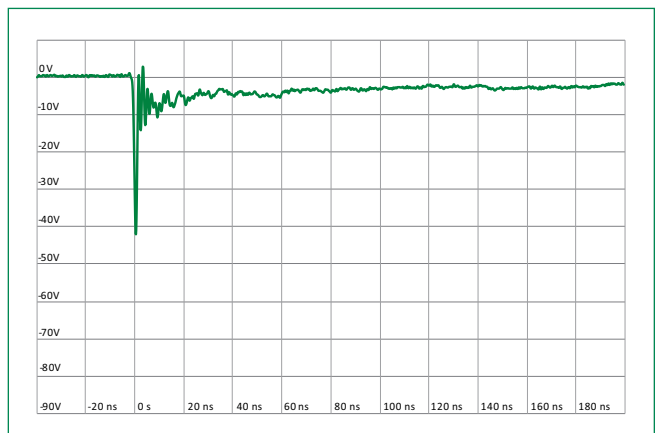
IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage



ISO10605 Contact Discharge Plot at +8KV



ISO10605 Contact Discharge Plot at -8 kV

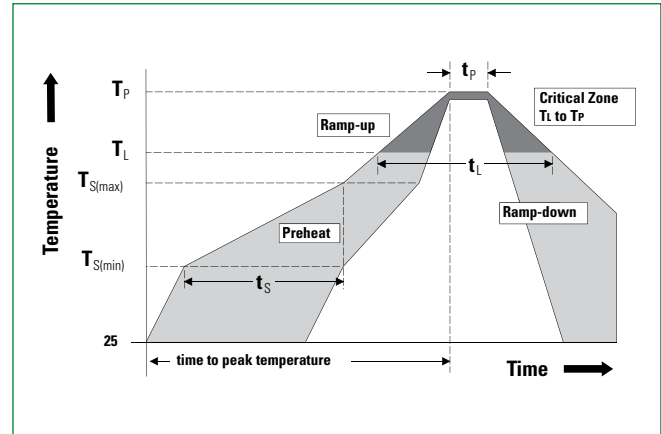


AQ7520-08UTG

0.32pF 12kV Diode Array, Low Capacitance ESD Protection

Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 120 secs
Average ramp up rate (Liquidus) Temp (T_L) to peak		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



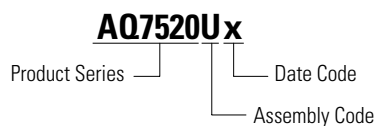
Ordering Information

Part Number	Package	Min. Order Qty.
AQ7520-08UTG	μDFN-9	3000

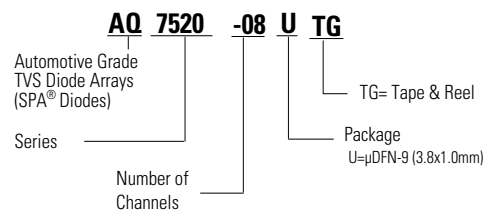
Product Characteristics

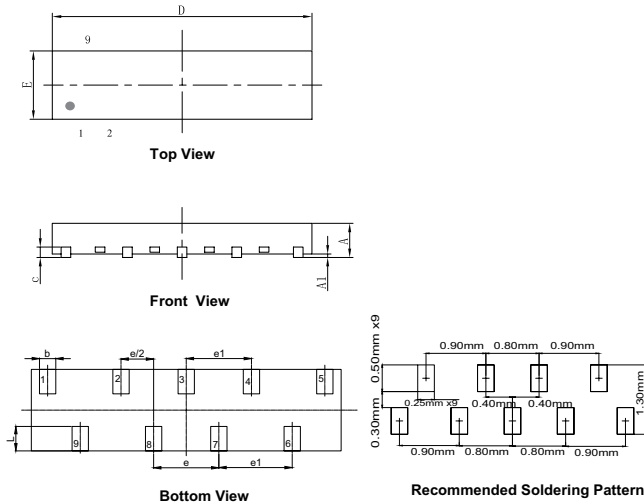
Lead Plating	Matte Tin
Lead material	Copper Alloy
Substrate Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

Part Marking System

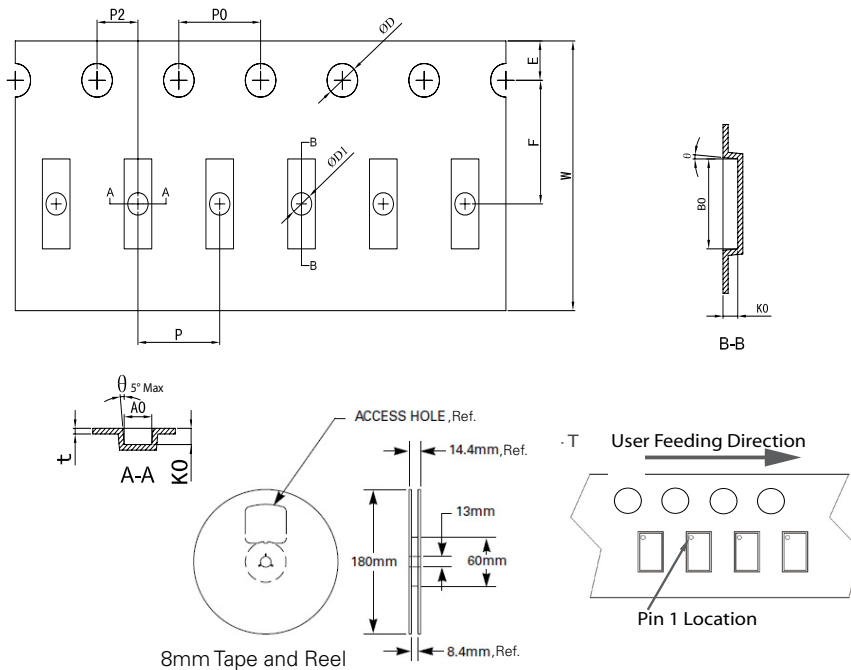


Part Numbering System



AQ7520-08UTG**0.32pF 12kV Diode Array, Low Capacitance ESD Protection****Package Dimensions**

μDFN-9 (3.8x1.0mm)						
Symbol	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.45	0.50	0.55	0.018	0.020	0.022
A1	-	0.02	0.05	-	0.001	0.002
b	0.15	0.20	0.25	0.006	0.008	0.010
c	0.10	0.15	0.20	0.004	0.006	0.008
D	3.70	3.80	3.90	0.146	0.150	0.154
e	0.80 BSC			0.031 BSC		
e1	0.90 BSC			0.035 BSC		
E	0.90	1.00	1.10	0.035	0.039	0.043
L	0.20	0.30	0.40	0.008	0.012	0.016

Embossed Carrier Tape & Reel Specification

Symbol	Millimeters
A0	1.35 +/- 0.10
B0	4.00 +/- 0.05
D	Ø 1.50 + 0.1/ - 0
D1	Ø 1.00 +/- 0.05
E	1.75 +/- 0.10
F	5.50 +/- 0.05
K0	0.72 +/- 0.05
P	4.00 +/- 0.10
P0	4.00 +/- 0.10
P2	2.00 +/- 0.05
T	0.25 +/- 0.02
W	12.00 + 0.30 / - 0.10

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